COT Control, 1.0A Synchronous Step-Down DC/DC Converters

■GENERAL DESCRIPTION

The XC9259 series is a group of synchronous-rectification type DC/DC converters with a built-in P-channel MOS driver transistor and N-channel MOS switching transistor, designed to allow the use of ceramic capacitors. Output voltage is internally set in a range from 0.8V to 3.6V (accuracy: ±2.0%) increments of 0.05V. The device provides a high efficiency, stable power supply with an output current of 1.0A to be configured using only a coil and two capacitors connected externally. Oscillation frequency is set to 1.2MHz or 6.0MHz can be selected for suiting to your particular application.

The operation mode is HISAT-COT ^(*) control, which has an excellent transient response. PWM control or PWM/PFM auto switching control can be selected at the MODE pin, and a high-speed response, low ripple, and high efficiency are achieved across the entire load range (from light loads to heavy loads).

During stand-by, all circuits are shutdown to reduce current consumption to as low as 1.0μ A or less. As for the soft-start function as fast as 0.3ms in typical for quick turn-on. With the built-in UVLO (Under Voltage Lock Out) function, the internal P-channel MOS driver transistor is forced OFF when input voltage becomes 2.00V or lower. The B types integrate C_L High Speed discharge function which enables the electric charge at the output capacitor C_L to be discharged via the internal discharge. The package is the ultra-small 1.2mm × 1.4mm × h0.3mm (LGA-8B01).

() HiSAT-COT is an original Torex term for High Speed Transient Response.

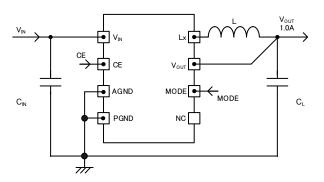
■APPLICATIONS

- Mobile phones
- Bluetooth headsets
- Smart phones, Personal digital assistance
- Portable game consoles
- Digital still cameras, Camcorders
- Point-of-Load (POL)
- •Wearable devices

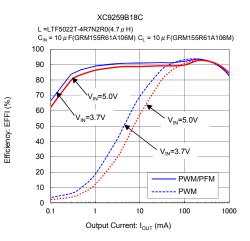
■FEATURES

Input Voltage Range	:	2.5V~5.5V
Output Voltage Range	:	0.8V~3.6V (±2.0%)
Oscillation Frequency	:	1.2MHz, 6.0MHz
Output Current	:	1A
Control Methods	:	HiSAT-COT Control
		100% Duty Cycle
		PWM Control
		PWM/PFM Auto
Protection Circuits	:	Thermal Shutdown
		Current Limit (Pendent character)
		Short Circuit Protection (Type B)
Functions	:	Soft-Start
		UVLO
		C _L High Speed Discharge (Type B)
Capacitor		Ceramic Capacitor
	•	•
Operating Ambient Temperature	:	- 40°C ∼ + 105°C
Package	:	LGA-8B01
Environmentally Friendly	:	EU RoHS Compliant, Pb Free
, , ,		. ,

TYPICAL APPLICATION CIRCUIT



■ TYPICAL PERFORMANCE CHARACTERISTICS

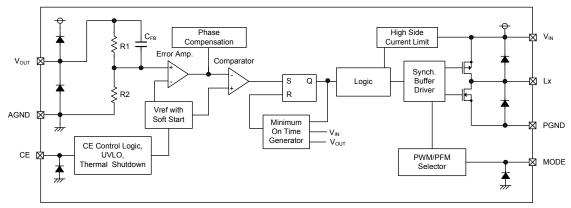


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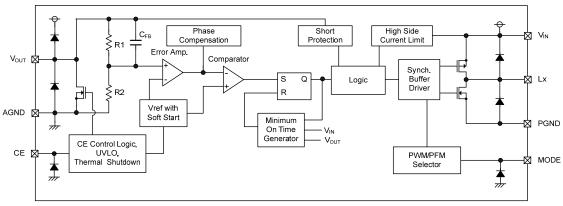
BLOCK DIAGRAM

1) XC9259 Series Type A



* Diodes inside the circuit are an ESD protection diode and a parasitic diode.

2) XC9259 Series Type B



* Diodes inside the circuit are an ESD protection diode and a parasitic diode.

■ PRODUCT CLASSIFICATION

1) Ordering Information

XC9259①23④56-⑦ PWM Control ⇔PWM/PFM Automatic switching control

DESIGNATOR	ITEM	SYMBOL	DESCRIPTION
1	Туре	A	Poter to Selection Cuide
U	туре	A BRefer to Selection GuideBOutput voltage options e.g. $1.2V \rightarrow @=1, @=2$ $1.25V \rightarrow @=1, @=C$ $0.05V$ increments : $0.05=A, 0.15=B, 0$ $0.35=D, 0.45=E, 0$	Relei to Selection Guide
23	Output Voltage	08~36	e.g. 1.2V → $(2)=1$, $(3)=2$ 1.25V → $(2)=1$, $(3)=C$ 0.05V increments : 0.05=A, 0.15=B, 0.25=C, 0.35=D, 0.45=E, 0.55=F, 0.65=H, 0.75=K, 0.85=L,
(4)	Oscillation Frequency	С	1.2MHz
4			6.0MHz
56-7 (*1)	Package (Order Unit)	1R-G	LGA-8B01 (5,000pcs/Reel)

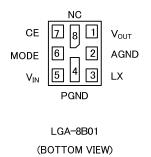
 $\ensuremath{^{(^1)}}$ The "-G" suffix denotes Halogen and Antimony free as well as being fully EU RoHS compliant.

2) Selection Guide

TYPE	OUTPUT VOLTAGE	CL AUTO-DISCHARGE	SHORT PROTECTION (LATCH)	UVLO
Α	Fixed	No	No	Yes
В	Fixed	Yes	Yes	Yes

TYPE	CHIP ENABLE	CURRENT LIMIT	SOFT-START TIME	THERMAL SHUTDOWN
А	Yes	Yes	Fixed	Yes
В	Yes	Yes	Fixed	Yes

■ PIN CONFIGURATION



* Please connect the AGND pin (No.2) and the PGND pin (No.4) when operating.

■ PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTIONS
LGA-8B01		FUNCTIONS
1	Vout	Output Voltage Monitor
2	AGND	Analog Ground
3	Lx	Switching Output
4	PGND	Power Ground
5	VIN	Power Input
6	MODE	MODE
7	CE	Chip Enable
8	NC	No Connection

FUNCTION

1) CE PIN Function

PIN NAME	SIGNAL	STATUS	
CF	L	Stand-by	
CE	Н	Active	

Please do not leave the CE pin open.

2) MODE PIN Function

PIN NAME	SIGNAL	STATUS
MODE	L	PWM/PFM automatic control
MODE	Н	PWM control

Please do not leave the MODE pin open.

■ABSOLUTE MAXIMUM RATINGS

				Ta=25°C
PARAMETE	R	SYMBOL	RATINGS	UNITS
V _{IN} Pin Volta	ge	V _{IN}	-0.3~+6.2	V
Lx Pin Volta	Lx Pin Voltage		-0.3~V _{IN} +0.3 or +6.2 ^(*1)	V
V _{OUT} Pin Volt	V _{OUT} Pin Voltage		-0.3~V _{IN} +0.3 or +4.0 ^(*2)	V
CE Pin Volta	ge	VCE	-0.3~+6.2	V
MODE Pin Vol	tage	V _{MDOE} -0.3~+6.2		V
Power Dissipation	Power Dissipation LGA-8B01		1000 (40mm x 40mm Standard board) $(*3)$	mW
Operating Ambient T	Operating Ambient Temperature		-40~+105	°C
Storage Temperature		Tstg	-55~+125	°C

All voltages are described based on the GND (AGND and PGND) pin.

 $^{(^{*}1)}\mbox{The}$ maximum value should be either $V_{IN}\mbox{+}0.3\mbox{V}$ or $\mbox{+}6.2\mbox{V}$ in the lowest.

 $^{(^{*}2)}$ The maximum value should be either V_{IN}+0.3V or +4.0V in the lowest.

 $^{\mbox{(\sc 3)}}$ The power dissipation figure shown is PCB mounted and is for reference only.

Please see the power dissipation page for the mounting condition.

■ ELECTRICAL CHARACTERISTICS

VC0250 Sorie

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage	V _{OUT}	When connected to external components, I_{OUT} =30mA V_{MODE} = V_{IN}	<e-1></e-1>	<e-2></e-2>	<e-3></e-3>	V	1
Operating Voltage Range	V _{IN}	-	2.5	-	5.5	V	1
Maximum Output Current	I _{OUTMAX}	When connected to external components $^{(^{*1})},$ $V_{\rm IN}{=}{<}C$ -1>	1000	-	-	mA	1
UVLO Voltage (*2)	V _{UVLO}	V_{OUT} = 0.6V,Voltage which Lx pin holding "L" level (*5)	1.35	2.0	2.48	V	3
Quiescent Current	la	f _{osc} =1.2MHz	-	15.0	25.0		2
Quescent Current	lq	$V_{OUT}=V_{OUT(T)}V \times 1.1V$ f _{osc} =6.0MHz	-	40.0	70.0	μA	Q
Stand-by Current	I _{STB}	V _{CE} =0.0V	-	0.0	1.0	μA	2
Minimum ON time	t _{onmin}	When connected to external components, $V_{IN}=V_{CE}=$, $I_{OUT}=1mA$	<e-5></e-5>	<e-6></e-6>	<e-7></e-7>	ns	1
Thermal shutdown	T _{TSD}	-	-	150	-	°C	1
Thermal shutdown hysteresis	T _{HYS}	-	-	30		°C	1
Lx SW"H"ON Resistance	R _{LXH}	V _{OUT} =0.6V, I _{LX} =100mA ^(*3)	-	0.18	0.32	Ω	4
Lx SW"L"ON Resistance	R _{LXL}	$V_{OUT}=V_{OUT(T)} V \times 1.1, V_{MODE}=5.0 V I_{LX}=100 mA$ (*3)	-	0.12	0.24	Ω	4
Lx SW"H" Leakage Current	I _{LeakH}	V_{IN} =5.5V, V_{CE} =0.0V, V_{OUT} = 0.0V, V_{LX} =5.5V	-	0.0	30.0	μA	5
Lx SW"L" Leakage Current	I _{leakL}	V_{IN} =5.5V, V_{CE} =0.0V, V_{OUT} =0.0V, V_{LX} =0.0V	-	0.0	1.0	μA	5
Current Limit (*4)	I _{LIMH}	V_{OUT} =0.6V I _{Lx} until Lx pin oscillates	1.3	1.5	2.5	А	6
Output Voltage Temperature Characteristics	ΔV _{ουτ} / (V _{ουτ} •ΔTopr)	I _{ou⊤} =30mA, -40°C≦Topr≦105°C	-	±100	-	ppm/°C	1
CE "H" Voltage	V _{CEH}	V_{OUT} =0.6V, Applied voltage to V_{CE} , Voltage changes Lx to "H" level (⁵⁾	1.40	-	5.5	V	3
CE "L" Voltage	V _{CEL}	$V_{\text{OUT}}\text{=}0.6V,$ Applied voltage to $V_{\text{CE}},$ Voltage changes Lx to "L" level $^{(*5)}$	AGND	-	0.30	V	3
CE "H" Current	I _{CEH}	V_{IN} =5.5V, V_{CE} =5.5V, V_{OUT} =0.0V	-0.1	-	0.1	μA	5
CE "L" Current	I _{CEL}	V_{IN} =5.5V, V_{CE} =0.0V, V_{OUT} =0.0V	-0.1	-	0.1	μA	5
Soft-Start Time	t _{ss}	V_{CE} =0.0V \rightarrow 5.0V V_{OUT} = $V_{OUT(T)}$ V × 0.9 After "H" is fed to CE, the time by when clocks are generated at Lx pin.	0.10	0.30	0.50	ms	3
Short Protection Threshold Voltage (Type B)	V _{SHORT}	Sweeping $V_{\text{OUT}},V_{\text{OUT}}$ voltage which Lx becomes "L" level $^{(^{\prime5)}}$	0.17	0.27	0.37	V	3
C_L Discharge (Type B)	R _{DCHG}	V _{CE} =0.0V, V _{OUT} =4.0V	50	210	300	Ω	7
MODE "H" Voltage	V _{MODEH}	Applied voltage to VMODE, Voltage for PWM Control	1.40	-	5.5	V	1
MODE "L" Voltage	V _{MODEL}	Applied voltage to VMODE, Voltage for PWM/PFM automatic control	AGND	-	0.30	V	1
MODE "H" Current	I _{MODEH}	$V_{\text{IN}}\text{=}5.5\text{V},V_{\text{CE}}\text{=}5.5\text{V},V_{\text{OUT}}\text{=}0.0\text{V}$ $V_{\text{MODE}}\text{=}5.5\text{V}$	-0.1	-	0.1	μA	5
MODE "L" Current	I _{MODEL}	V_{IN} =5.5V, V_{CE} =5.5V, V_{OUT} =0.0V V_{MODE} =0.0V	-0.1	-	0.1	μA	5

Unless otherwise stated, V_{IN} =5.0V, V_{CE} =5.0V, V_{MODE} =0V, $V_{OUT(T)}$ =Nominal Value

NOTE:

(*1) When the difference between the input and the output is small, 100% duty might come up and internal control circuits keep P-ch driver turning on even though the output current is not so large.

- If current is further pulled from this state, output voltage will decrease because of P-ch driver ON resistance.
- ^('2) Including UVLO detect voltage, hysteresis operating voltage range for UVLO release voltage.
- (*3) RLXH=(VIN Lx pin measurement voltage) / 100mA, RLXL=Lx pin measurement voltage / 100mA
- (*4) Current limit denotes the level of detection at peak of coil current.

 $^{(*5)}$ "H"=V_{IN} - 1.2V ~ V_{IN}, "L"=- 0.1V ~ + 0.1V

■ ELECTRICAL CHARACTERISTICS (Continued)

SPEC Table

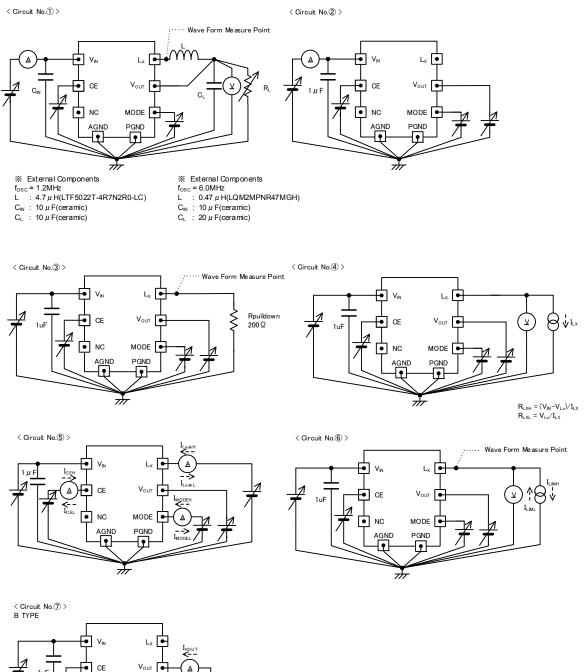
NOMINAL							t _{ONmin}			
OUTPUT	V _{OUT}				f _{OS}	_{sc} = 1.2Mł		f _O ;	_{sc} = 6.0MI	Ηz
VOLTAGE	<e-1></e-1>	<e-2></e-2>	<e-3></e-3>	<c-1></c-1>	<e-5></e-5>	<e-6></e-6>	<e-7></e-7>	<e-5></e-5>	<e-6></e-6>	<e-7></e-7>
V _{OUT(T)}	MIN.	TYP.	MAX.	V _{IN}	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
0.80	0.784	0.800	0.816	2.50	173	247	321	16	53	91
0.85	0.833	0.850	0.867	2.50	184	262	341	18	57	95
0.90	0.882	0.900	0.918	2.50	194	278	361	21	60	99
0.95	0.931	0.950	0.969	2.50	205	293	381	23	63	104
1.00	0.980	1.000	1.020	2.50	216	309	401	26	67	108
1.05	1.029	1.050	1.071	2.50	227	324	421	29	70	112
1.10	1.078	1.100	1.122	2.50	238	340	441	31	73	115
1.15	1.127	1.150	1.173	2.50	248	355	461	35	77	119
1.20	1.176	1.200	1.224	2.50	259	370	481	38	80	122
1.25	1.225	1.250	1.275	2.50	270	386	502	41	83	126
1.30	1.274	1.300	1.326	2.50	281	401	522	45	87	129
1.35	1.323	1.350	1.377	2.50	292	417	542	48	90	132
1.40	1.372	1.400	1.428	2.50	302	432	562	52	93	135
1.45	1.421	1.450	1.479	2.50	313	448	582	56	97	137
1.50	1.470	1.500	1.530	2.50	324	463	602	60	100	140
1.55	1.519	1.550	1.581	2.58	335	478	622	60	100	140
1.60	1.568	1.600	1.632	2.67	346	494	642	60	100	140
1.65	1.617	1.650	1.683	2.75	350	500	650	60	100	140
1.70	1.666	1.700	1.734	2.83	350	500	650	60	100	140
1.75	1.715	1.750	1.785	2.92	350	500	650	60	100	140
1.80	1.764	1.800	1.836	3.00	350	500	650	60	100	140
1.85	1.813	1.850	1.887	3.08	350	500	650	60	100	140
1.90	1.862	1.900	1.938	3.17	350	500	650	60	100	140
1.95	1.911	1.950	1.989	3.25	350	500	650	60	100	140
2.00	1.960	2.000	2.040	3.33	350	500	650	60	100	140
2.05	2.009	2.050	2.091	3.42	350	500	650	60	100	140
2.10	2.058	2.100	2.142	3.50	350	500	650	60	100	140
2.15	2.107	2.150	2.193	3.58	350	500	650	60	100	140
2.20	2.156	2.200	2.244	3.67	350	500	650	60	100	140
2.25	2.205	2.250	2.295	3.75	350	500	650	60	100	140
2.30	2.254	2.300	2.346	3.83	350	500	650	60	100	140
2.35	2.303	2.350	2.397	3.92	350	500	650	60	100	140
2.40	2.352	2.400	2.448	4.00	350	500	650	60	100	140
2.45	2.401	2.450	2.499	4.08	350	500	650	60	100	140
2.50	2.450	2.500	2.550	4.17	350	500	650	60	100	140
2.55	2.499	2.550	2.601	4.25	350	500	650	60	100	140
2.60	2.548	2.600	2.652	4.33	350	500	650	60	100	140
2.65	2.597	2.650	2.703	4.42	350	500	650	60	100	140
2.70	2.646	2.700	2.754	4.50	350	500	650	60	100	140

■ELECTRICAL CHARACTERISTICS (Continued)

SPEC Table

NOMINAL		Vout					t _{ONmin}			
OUTPUT		VOUI			f _C	_{sc} =1.2M⊢	lz	fc	osc=6.0MHz	
VOLTAGE	<e-1></e-1>	<e-2></e-2>	<e-3></e-3>	<c-1></c-1>	<e-5></e-5>	<e-6></e-6>	<e-7></e-7>	<e-5></e-5>	<e-6></e-6>	<e-7></e-7>
V _{OUT(T)}	MIN.	TYP.	MAX.	V _{IN}	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
2.75	2.695	2.750	2.805	4.58	350	500	650	60	100	140
2.80	2.744	2.800	2.856	4.67	350	500	650	60	100	140
2.85	2.793	2.850	2.907	4.75	350	500	650	60	100	140
2.90	2.842	2.900	2.958	4.83	350	500	650	60	100	140
2.95	2.891	2.950	3.009	4.92	350	500	650	60	100	140
3.00	2.940	3.000	3.060	5.00	350	500	650	60	100	140
3.05	2.989	3.050	3.111	5.08	350	500	650	60	100	140
3.10	3.038	3.100	3.162	5.17	350	500	650	60	100	140
3.15	3.087	3.150	3.213	5.25	350	500	650	60	100	140
3.20	3.136	3.200	3.264	5.33	350	500	650	60	100	140
3.25	3.185	3.250	3.315	5.42	350	500	650	60	100	140
3.30	3.234	3.300	3.366	5.50	350	500	650	60	100	140
3.35	3.283	3.350	3.417	5.50	355	508	660	61	102	142
3.40	3.332	3.400	3.468	5.50	361	515	670	62	103	144
3.45	3.381	3.450	3.519	5.50	366	523	680	63	105	146
3.50	3.430	3.500	3.570	5.50	371	530	689	64	106	148
3.55	3.479	3.550	3.621	5.50	377	538	699	65	108	151
3.60	3.528	3.600	3.672	5.50	382	545	709	65	109	153

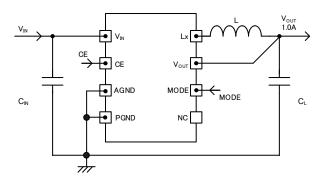
■TEST CIRCUITS



Tuf CE Vour A AGND POND

> TOIREX 9/28

TYPICAL APPLICATION CIRCUIT



[Typical Examples] fosc=1.2MHz

	MANUFACTURER	PRODUCT NUMBER	VALUE
	murata	LQH5BPN4R7NT0L	4.7µH
L	TDK	LTF5022T-4R7N2R0-LC	4.7µH
	Coilcraft	XFL4020-472MEC	4.7µH

[Typical Examples] forc=6.0MHz

	-		
	MANUFACTURER	PRODUCT NUMBER	VALUE
L	murata	LQM2MPNR47MGH	0.47µH
	ALPS	GLCLKR4701A	0.47µH
	TAIYO YUDEN	MAKK2016TR47M	0.47µH
	TDK	MLP2520HR47MT0S1	0.47µH

【Typical Examples】 (*1) fosc=1.2MHz

	MANUFACTURER	PRODUCT NUMBER	VALUE
	murata	GRM155R61A106M	10µF/10V
CIN	murata	GRM21BR71A106KE51	10µF/10V
	TAIYO YUDEN	LMK212AB7106MG	10µ/10V
CL	murata	GRM155R61A106M	10µF/10V ^(*2)
	murata	GRM21BR71A106KE51	10µF/10V ^(*2)
	TAIYO YUDEN	LMK212AB7106MG	10µF/10V ^(*2)

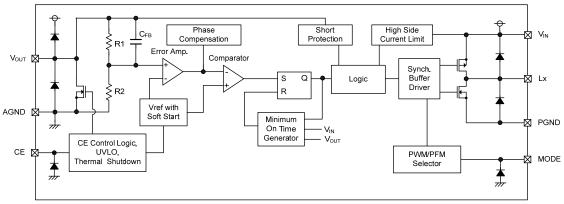
[Typical Examples] (*1) fosc=6.0MHz

	MANUFACTURER	PRODUCT NUMBER	VALUE
	murata	GRM155R61A106M	10µF/10V
CIN	murata	GRM21BR71A106KE51	10µF/10V
	TAIYO YUDEN	LMK212AB7106MG	10µF/10V
C∟	murata	GRM155R61A106M	10µF/10V 2parallel
	murata	GRM21BR71A226KE51	22µF/10V
	TAIYO YUDEN	LMK212AB7226MG	22µF/10V

(*1) Select components appropriate to the usage conditions (ambient temperature, input & output voltage).

■OPERATIONAL EXPLANATION

The XC9259 series consists of a reference voltage source, error amplifier, comparator, phase compensation, minimum on time generation circuit, output voltage adjustment resistors, P-channel MOS driver transistor, N-channel MOS switching transistor for the synchronous switch, current limiter circuit, UVLO circuit, thermal shutdown circuit, short protection circuit, PWM/PFM selection circuit and others. (See the BLOCK DIAGRAM below.)



BLOCK DIAGRAM XC9259 Series Type B

The method is HiSAT-COT (High Speed circuit Architecture for Transient with Constant On Time) control, which features on time control method and a fast transient response that also achieves low output voltage ripple.

The on time (t_{on}) is determined by the input voltage and output voltage, and turns on the Pch MOS driver Tr. for a fixed time. During the off time (t_{off}), the voltage that is fed back through R1 and R2 is compared to the reference voltage by the error amp, and the error amp output is phase compensated and sent to the comparator. The comparator compares this signal to the reference voltage, and if the signal is lower than the reference voltage, sets the SR latch. On time then resumes. By doing this, PWM operation takes place with the off time controlled to the optimum duty ratio and the output voltage is stabilized. The phase compensation circuit optimizes the frequency characteristics of the error amp, and generates a ramp wave similar to the ripple voltage that occurs in the output to modulate the output signal of the error amp. This enables a stable feedback system to be obtained even when a low ESR capacitor such as a ceramic capacitor is used, and a fast transient response and stabilization of the output voltage are achieved.

<Minimum on time generation circuit>

Generates an on time that depends on the input voltage and output voltage (ton). The on time is set as given by the equations below.

$$f_{OSC} \rightleftharpoons 1.2MHz type$$

$$t_{on} (\mu s) = V_{OUT}/V_{IN} \times 0.833$$

$$f_{OSC} \rightleftharpoons 6.0MHz type$$

$$t_{on} (\mu s) = V_{OUT}/V_{IN} \times 0.167$$

<Switching frequency>

The switching frequency can be obtained from the on time (t_{on}), which is determined by the input voltage and output voltage, and the PWM controlled off time (t_{off}) as given by the equation below.

 $f_{OSC} (MHz) = V_{OUT}(V) / (V_{IN}(V) \times t_{on}(\mu s))$

<100% duty cycle mode>

When the load current is heavy and the voltage difference between input voltage and output voltage is small, 100% duty cycle mode is activated and it keeps the Pch MOS driver Tr. keep on. 100% duty cycle mode attains a high output voltage stability and a high-speed response under all load conditions, from light to heavy, even in conditions where the dropout voltage is low.

<Error amp>

The error amp monitors the output voltage. The voltage divided by the internal R1 and R2 resistors is a feedback voltage for Error Amp. and compared to the reference voltage. The output voltage of the error amp becomes higher when the feedback voltage is higher than the reference voltage. The frequency characteristics of the error amp are optimized internally.

OPERATIONAL EXPLANATION (Continued)

<Reference voltage source, soft start function>

The reference voltage forms a reference that is used to stabilize the output voltage of the IC.

After "H" level is fed to CE pin, the reference voltage connected to the error amp increases linearly during the soft start interval. This allows the voltage divided by the internal R1 and R2 resistors and the reference voltage to be controlled in a balanced manner, and the output voltage rises in proportion to the rise in the reference voltage. This operation prevents rush input current and enables the output voltage to rise smoothly.

If the output voltage does not reach the set output voltage within the soft start time, such as when the load is heavy or a large capacity output capacitor is connected, the balancing of the voltage divided by the internal resistors R1 and R2 and the reference voltage is lost, however, the current restriction function activates to prevent an excessive increase of input current, enabling a smooth rise of the output voltage.

<MODE function>

XC9259 series is selectable on the control method between PWM control and PWM/PFM auto switching control by using MODE pin. When "H" level is fed to MODE pin, XC9259works with PWM control, whereas when "L" level is fed to MODE pin, it works with PWM/PFM auto switching control.

Under PWM control, XC9259 works with the continuous conduction mode (CCM) and ON-duty is decided based on the relationship between the input voltage and the output voltage regardless the output current, and the switching frequency is stable. On the other hand, under PWM/PFM auto switching control, XC9259 can work with the discontinuous conduction mode (DCM) when the output current is low and the switching frequency varies to lower frequency so that the switching loss reduces and, as a result, the efficiency is improved.

MODE pin has CMOS input configuration and the sink current is 0µA.

<CE function>

Operation starts when "H" voltage is fed to the CE pin. The IC can be put in the shutdown state by inputting "L" voltage into the CE pin. In the shutdown state, the supply current of the IC is $0\mu A$ (TYP.), and the Pch MOS driver Tr. and Nch MOS switch Tr. for synchronous rectification turn off. The CE pin is a CMOS input and the sink current is $0\mu A$.

<UVLO Circuit>

When the V_{IN} voltage becomes 2.00V (TYP.) or lower, the P-ch MOS driver transistor output driver transistor is forced OFF to prevent false pulse output caused by unstable operation of the internal circuitry. When the V_{IN} pin voltage becomes 2.10V (TYP.) or higher, switching operation takes place. By releasing the UVLO function, the IC performs the soft start function to initiate output startup operation. The UVLO circuit does not cause a complete shutdown of the IC, but causes pulse output to be suspended; therefore, the internal circuitry remains in operation.

<Thermal Shutdown>

For protection against heat damage of the ICs, thermal shutdown function monitors chip temperature. The thermal shutdown circuit starts operating and the P-ch MOS driver and N-ch MOS driver transistor will be turned off when the chip's temperature reaches 150°C. When the temperature drops to 120°C (TYP.) or less after shutting of the current flow, the IC performs the soft-start function to initiate output startup operation.

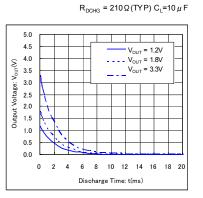
<Short-circuit protection function>

The B type short-circuit protection circuit protects the device that is connected to this product and to the input/output in situations such as when the output is accidentally shorted to GND. The short-circuit protection circuit monitors the output voltage, and when the output voltage falls below the short-circuit protection threshold voltage, it turns off the Pch MOS driver Tr and latches it. Once in the latched state, operation is resumed by turning off the IC from the CE pin and then restarting, or by re-input into the V_{IN} pin.

<CL High Speed Discharge>

The B type can quickly discharge the electric charge at the output capacitor (C_L) when a low signal to the CE pin which enables a whole IC circuit put into OFF state, is inputted via the N-ch MOS switch transistor located between the V_{OUT} pin and the GND pin. When the IC is disabled, electric charge at the output capacitor (C_L) is quickly discharged so that it may avoid application malfunction. Output Voltage Dischage characteristics

> $V=V_{OUT(T)} \times e^{-t/\tau}$ $t= \tau \ln (V_{OUT(T)} / V)$ V: Output voltage after discharge V_{OUT(T)}: Output voltage t: Discharge time $\tau : C_L \times R_{DCHG}$ CL: Capacitance of Output capacitor R_DCHG: CL auto-discharge resistance, but it depends on supply voltage.



■ OPERATIONAL EXPLANATION (Continued)

<Current Limit>

The current limiter circuit of the XC9259 series monitors the current flowing through the P-channel MOS driver transistor connected to the Lx pin. When the driver current is greater than a specific level, the current limit function operates to turn off the pulses from the Lx pin at any given timing. When the over current state is eliminated, the IC resumes its normal operation.

■NOTE ON USE

- 1. For the phenomenon of temporal and transitional voltage decrease or voltage increase, the IC may be damaged or deteriorated if IC is used beyond the absolute MAX. specifications.
- 2. Spike noise and ripple voltage arise in a switching regulator as with a DC/DC converter. These are greatly influenced by external component selection, such as the coil inductance, capacitance values, and board layout of external components. Once the design has been completed, verification with actual components should be done.
- 3. The DC/DC converter characteristics depend greatly on the externally connected components as well as on the characteristics of this IC, so refer to the specifications and standard circuit examples of each component when carefully considering which components to select. Be especially careful of the capacitor characteristics and use B characteristics (JIS standard) or X7R, X5R (EIA standard) ceramic capacitors.
- 4. Make sure that the PCB GND traces are as thick and wide as possible. The PGND pin and AGND pin fluctuation caused by high ground current at the time of switching may result in instability of the IC. Therefore, the GND traces close to the PGND pin and AGND pin are important.
- 5. Mount external components as close as possible to the IC. Keep the wiring short and thick to lower the wiring impedance.
- 6. A feature of HiSAT-COT control is that it controls the off time in order to control the duty, which varies due to the effects of power loss. In addition, changes in the on time due to 100% duty cycle mode are allowed. For this reason, caution must be exercised as the characteristics of the switching frequency will vary depending on the external component characteristics, board layout, input voltage, output voltage, load current and other parameters.
- 7. Due to propagation delay inside the product, the on time generated by the minimum on time generation circuit is not the same as the on time that is the ratio of the input voltage to the output voltage.
- 8. With regard to the current limiting value, the actual coil current may at times exceed the electrical characteristics due to propagation delay inside the product.
- 9. The CE pin and the Mode pin are a CMOS input pin. Do not use with the pin open. If connecting to the input or ground, use the resistor not more than $1M\Omega$ or less. To prevent malfunctioning of the device connected to this product or the input/output due to short circuiting between pins, it is recommended that a resistor be connected.
- 10. In the B type, if the output voltage drops below the short circuit protection threshold voltage at the end of the soft start interval, operation will stop.
- 11. Regarding PWM/PFM auto switching control method, it works with a discontinuous conduction mode at light loads, and in this case where the voltage difference between input voltage and output voltage is low or the coil inductance is higher than the value indicated in the standard circuit example, the coil current may reverse when the load is light, and thus pulse skipping will not be possible and light load efficiency will worsen.
- 12. When the input voltage is close to the minimum input voltage, the current limit circuit might not be able to work.
- 13. When the voltage difference between input voltage and output voltage is low, the load stability feature may deteriorate.

■NOTE ON USE (Continued)

- 14. If the capacitance value is not sufficient by degrading CL due to the low temp. condition and DC bias feature, 100% duty cycle might come up for the load transient condition. Add capacitance value for CL if necessary. (Refer to Fig14-1, Fig14-2, Fig14-3, Fig.14-4)
 - <Conditions> Ta=-40°C,V_{IN}=3.6V,V_{OUT}=1.5V f_{OSC} =1.2MHz, I_{OUT} =1000mA \rightarrow 10mA <External Components> L : 4.7 μ H,C_{IN} : 10 μ F (ceramic),C_L : 10 μ F (ceramic)

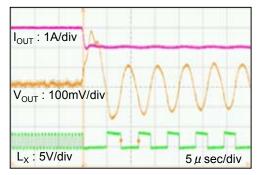


Fig.14-1 Insufficient C₁ (Ta=-40°C,C₁=10 μ F)

<Conditions> Ta=-40°C,V_{IN}=3.6V,V_{OUT}=1.5V f_{OSC}=1.2MHz,I_{OUT}=10mA→1000mA <External Components> L : 4.7 μ H,C_{IN} : 10 μ F (ceramic),C_L : 10 μ F (ceramic)

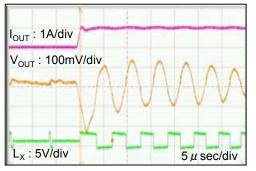
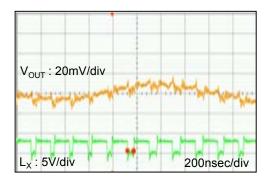


Fig.14-3 Insufficient C₁ (Ta=-40°C,C₁=10 μ F)

- 15. If the capacitance value is not sufficient by degrading C_L due to the low temp. condition and DC bias feature, the duty cycle might not be stable. Add capacitance value for CL if necessary. (Refer to Fig.15-1, Fig.15-2)
 - <Conditions>
 - Ta=25°C,V_{IN}=2.5V,V_{OUT}=0.8V
 - f_{OSC}=6.0MHz,I_{OUT}=300mA <External Components>

L :0. 47 μ H,C_{IN} : 10 μ F (ceramic),C_L : 10 μ F (ceramic)



<Conditions> Ta=-40°C,V_{IN}=3.6V,V_{OUT}=1.5V f_{OSC} =1.2MHz, I_{OUT} =1000mA \rightarrow 10mA <External Components> L : 4.7 μ H,C_{IN} : 10 μ F (ceramic),C_L : 20 μ F (ceramic)

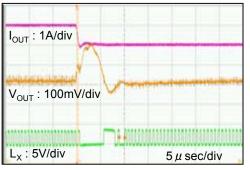


Fig.14-2 Sufficient C₁ (Ta=-40°C,C₁=20 μ F)

```
<Conditions>
Ta=-40°C,V<sub>IN</sub>=3.6V,V<sub>OUT</sub>=1.5V
f_{OSC}=1.2MHz,I_{OUT}=10mA\rightarrow1000mA
```

<External Components>

L : 4.7 μ H,C_{IN} : 10 μ F (ceramic),C_L : 20 μ F (ceramic)

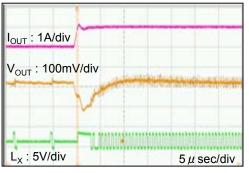
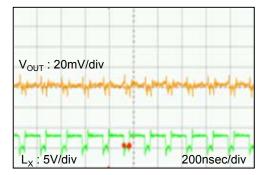


Fig.14-4 Sufficient C₁ (Ta=-40°C,C₁=20 μ F)

<Conditions>

Ta=25°C,V_{IN}=2.5V,V_{OUT}=0.8V f_{OSC}=6.0MHz,I_{OUT}=300mA <External Components> L :0. 47 μ H,C_{IN} : 10 μ F (ceramic),C_L : 20 μ F (ceramic)



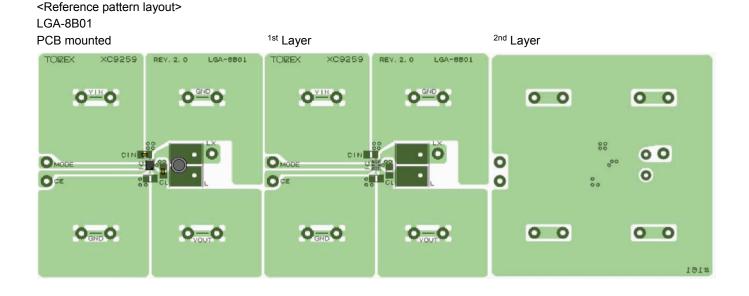
16. Torex places an importance on improving our products and their reliability. We request that users incorporate fail-safe designs and post-aging protection treatment when using Torex products in their systems.

■NOTE ON USE (Continued)

17. Instructions of pattern layouts

The operation may become unstable due to noise and/or phase lag from the output current when the wire impedance is high, please place the input capacitor(C_{IN}) and the output capacitor (C_L) as close to the IC as possible.

- (1) In order to stabilize V_{IN} voltage level, we recommend that a by-pass capacitor (C_{IN}) be connected as close as possible to the V_{IN} pin, PGND pin and AGND pin.
- (2) Please mount each external component as close to the IC as possible.
- (3) Wire external components as close to the IC as possible and use thick, short connecting traces to reduce the circuit impedance.
- (4) Make sure that the GND traces are as thick as possible, as variations in ground potential caused by high ground currents at the time of switching may result in instability of the IC.
- (5) This series' internal driver transistors bring on heat because of the output current and ON resistance of P-channel and N-channel MOS driver transistors. Please consider the countermeasures against heat if necessary.

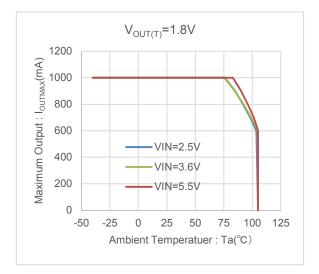


■NOTE ON USE (Continued) < Estimation for the power consumption > The power loss of a total buck DC/DC system (P all) is as follows. $P_{all}(W) = V_{IN} \times I_{IN} - V_{OUT} \times I_{OUT}$ = Vout × Iout/EFFI-Vout × Iout =-Vout × Iout × (1-1/EFFI) VIN: Input voltage, Vout: Output voltage, IIN: Input current, Iout: Output current, EFFI: Efficiency The power loss at a coil (P coil) is as follows. $P_{coil}(W) = I_{OUT}^2 \times DCR$ DCR: The direct current resistance of a coil The power loss at IC (P_IC) can be calculated by subtracting the power loss at a coil from the one of a total buck DC/DC system. $P_IC(W) = P_all - P_coil$ The temperature of IC (Tj) can be calculated by the function below. $T_j = T_a + R \times P IC$ R: Thermal resistance The temperature resistance varies based on the power dissipation of a PC board and so on. Please note that Tj should be lower than 125°C Calculation Example Conditions : VIN=2.5V, VOUT=1.8V, IOUT=800mA, EFFI=81.4% R=100°C/W DCR=0.06 Ω The power loss of a total buck DC/DC system (P_{all}) =- $V_{OUT} \times I_{OUT} \times (1-1/EFFI)$ =-1.8 × 0.8 × (1-1/0.814) ≑0.329(W) The power loss at a coil (P_{coil}) = $I_{OUT}^2 \times DCR$ $= 0.8^2 \times 0.06$ ≑0.038 (W) The power loss at IC (P_IC) = P_all - P_coil = 0.329 -0.038 = 0.290 (W)The temperature of IC (Ti) = The ambient temperature so that Ti becomes $125 \,^{\circ}$ C (Ta) = Ti-R*P IC =125-100 × 0.290

In this case, under the condition above, the ambient temperature up to 96°C is acceptable.

Reference example

Ta-IOUTMAX feature example with LGA-8B01 recommendation PCB pattern



1. Measurement Condition				
Condition:	Mount on a board			
Ambient:	Natural convection			
Soldering:	Lead (Pb) free			
Board:	Dimensions 40 x 40 mm (1600 mm ² in one side)			
	(Reference pattern layout of LGA-8B01:			
	Refer to page 15)			
Copper thickness:	18μm(Cu)+20μm(plating)=38μm			
Material:	Glass Epoxy (FR-4)			
Thickness:	0.8mm			
Through-hole	10 x 0.3 Diameter			
	2 x 0.8 Diameter			
	10 x 1.0 Diameter			

=96.0℃

■TYPICAL PERFORMANCE CHARACTERISTICS

(1) Efficiency vs. Output Current

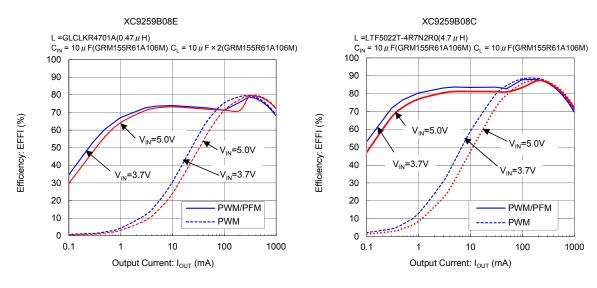
20

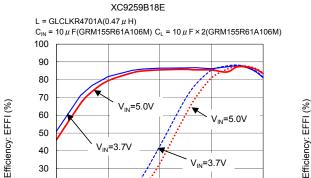
10

0

0.1

1





10

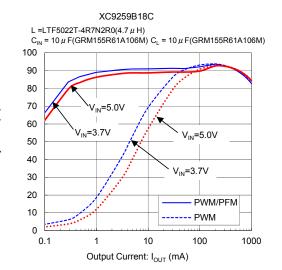
Output Current: I_{OUT} (mA)

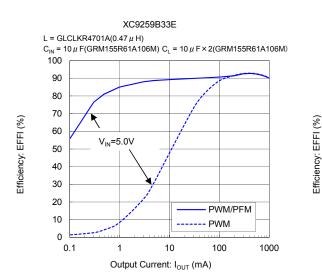
PWM/PFM

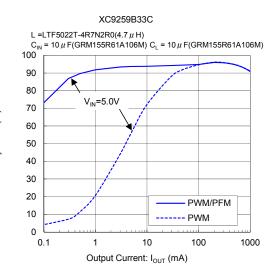
1000

---- PWM

100



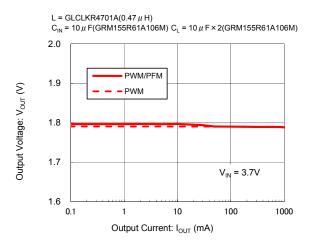




■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

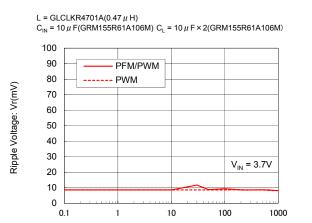
(2) Output Voltage vs. Output Current

XC9259A18E



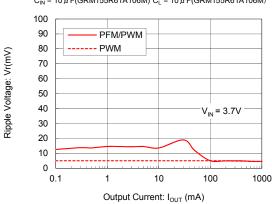
(3) Ripple Voltage vs. Output Current

XC9259B18E

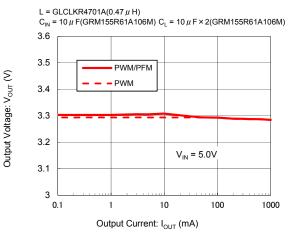


Output Current: I_{OUT} (mA)

XC9259B18C

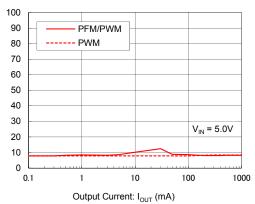


L =LTF5022T-4R7N2R0(4.7 μ H) C_{IN} = 10 μ F(GRM155R61A106M) C_L = 10 μ F(GRM155R61A106M)



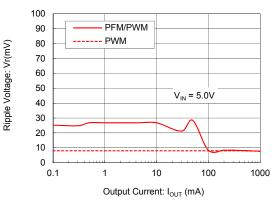
XC9259A33E

XC9259B33E



L = GLCLKR4701A(0.47 μ H) C $_{\rm IN}$ = 10 μ F(GRM155R61A106M) C $_{\rm L}$ = 10 μ F \times 2(GRM155R61A106M)

XC9259B33C



L =LTF5022T-4R7N2R0(4.7 μ H) C __N = 10 μ F(GRM155R61A106M) C _ = 10 μ F(GRM155R61A106M)

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Ripple Voltage: Vr(mV)

■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

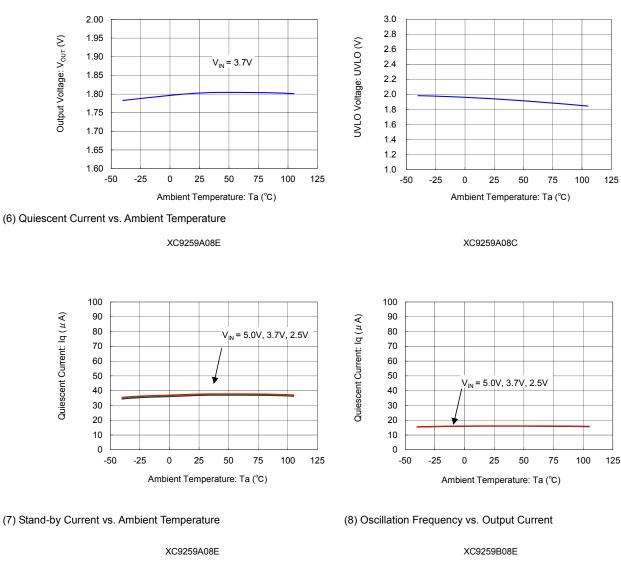
(4) Output Voltage vs. Ambient Temperature

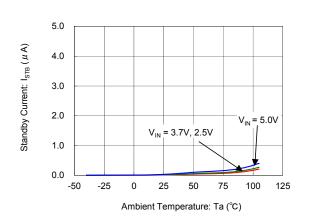
(5) UVLO Voltage vs. Ambient Temperature

XC9259B18E

OVLO Voltage VS. Ambient Temperatu

XC9259A08E

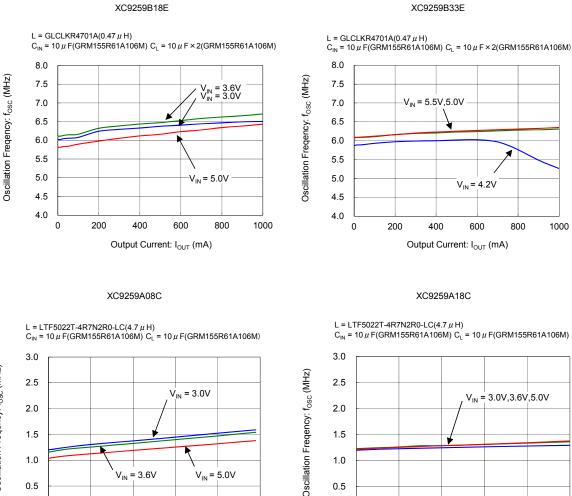


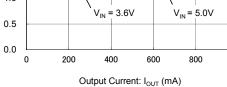


L = GLCLKR4701A(0.47 μ H) C_IN = 10 μ F(GRM155R61A106M) C_L = 10 μ F \times 2(GRM155R61A106M) 8.0 Oscillation Freqency: f_{osc} (MHz) 7.5 = 3.6V $V_{IN} = 3.0V$ 7.0 6.5 6.0 5.5 5.0 V_{IN} = 5.0V 4.5 4.0 0 200 400 600 800 1000 Output Current: I_{OUT} (mA)

■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Oscillation Frequency vs. Output Current (Continued)

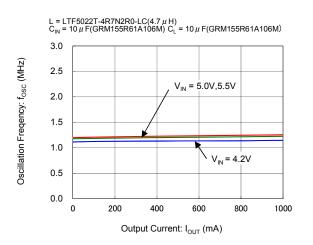




XC9259A33C

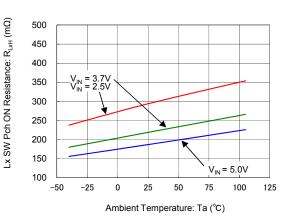
0.5 0.0 0 200

(9) Pch Driver ON Resistance vs. Ambient Temperature



1000





400

Output Current: I_{OUT} (mA)

600

800

1000

Oscillation Freqency: f_{osc} (MHz)

■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

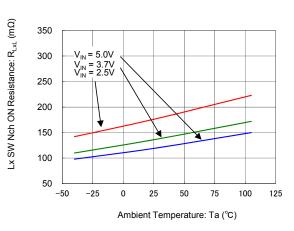
(10) Nch Driver ON Resistance vs. Ambient Temperature

(11) LxSW "L" Leakage Current vs. Ambient Temperature

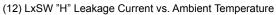
10.0 9.0

8.0

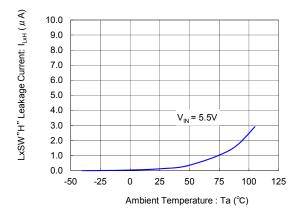
XC9259A08E



XC92659A08E

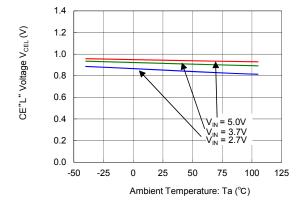


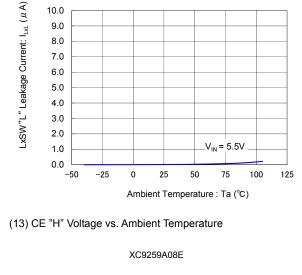
XC9259A08E

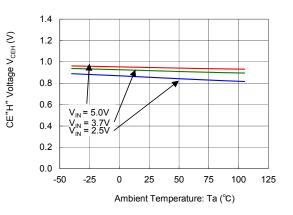




XC9259A08E

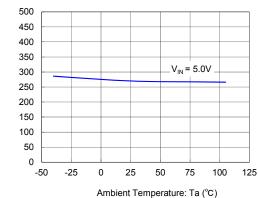






(15) Soft-Start Time vs. Ambient Temperature

XC9259B08E



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Soft-Start Time: t_{ss} (us)

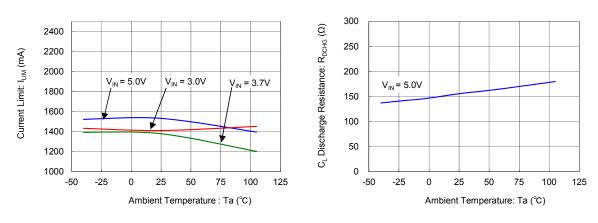
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(16) Current Limit vs. Ambient Temperature

(17) CL Discharge Resistance vs. Ambient Temperature

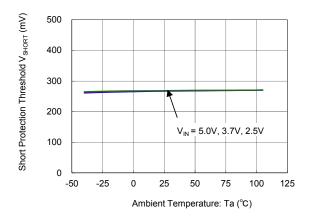


XC9259B08E



(18) Short Protection Threshold vs. Ambient Temperature

XC9259B08E



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(19) Load Transient Response

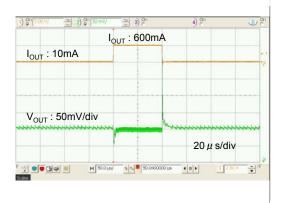
XC9259A12E (PWM Control)

 $C_1 = 10 \,\mu\,F \times 2(GRM155R61A106M)$

1) 8 2 3) 4) I_{OUT} : 600mA I_{OUT}: 10mA V_{OUT}: 50mV/div 20 µ s/div H 50.0 LB/ 5 🔨 📕 50.0400000 µs 40 > T 2.50 -

 $V_{IN} = 5.0V V_{OUT} = 1.2V f_{OSC} = 6.0MHz I_{OUT} = 10mA ⇒ 600mA L = GLCLKR4701A(0.47 <math>\mu$ H)C_{IN} = 10 μ F(GRM155R61A106M)

XC9259B12E (PWM/PFM Automatic Control) V_{IN} = 5.0V V_{OUT} = 1.2V f_{OSC} = 6.0MHz I_{OUT} = 10mA \Rightarrow 600mA L = GLCLKR4701A(0.47 μ H)C_{IN} = 10 μ F(GRM155R61A106M) $C_1 = 10 \,\mu\,F \times 2(GRM155R61A106M)$

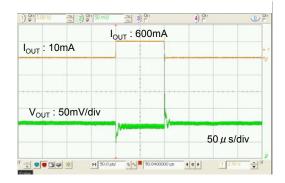


XC9259A18E (PWM Control)

 V_{IN} = 5.0V V_{OUT} = 1.8V f_{OSC} = 6.0MHz I_{OUT} = 10mA \Rightarrow 600mA L = GLCLKR4701A(0.47 μ H)C_{IN} = 10 μ F(GRM155R61A106M) $C_{L} = 10 \,\mu \,F \times 2(GRM155R61A106M)$

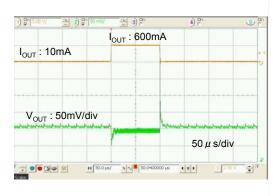
1) 🛱 (300 V/	≥ 2) Br (20 mW	3 8	4) 🕾	0 0
	I,	_{DUT} : 600mA		
I _{OUT} : 10r	nA			* 1
				, ¹ 1
****			***	
V _{оит} : 5	0mV/div			
			50 μ s/div	v
	ж H 30.0 µs/	s n = 50.0400000 µs	< 0 > T 2 >	
	- <u> </u>			•

XC9259A33E (PWM Control) V_{IN} = 5.0V V_{OUT} = 3.3V f_{OSC} = 6.0MHz I_{OUT} = 10mA \Rightarrow 600mA $\begin{array}{l} L = GLCLKR4701A(0.47\,\mu\,\text{H})C_{\text{IN}} = 10\,\mu\,\text{F}(\text{GRM155R61A106M}) \\ C_{\text{L}} = 10\,\mu\,\text{F} \times 2(\text{GRM155R61A106M}) \end{array}$

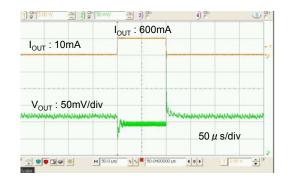


XC9259A18E (PWM/PFM Automatic Control)

 $V_{\text{IN}} = 5.0V V_{\text{OUT}} = 1.8V f_{\text{OSC}} = 6.0\text{MHz} I_{\text{OUT}} = 10\text{mA} \Rightarrow 600\text{mA}$ $L = \text{GLCLKR4701A}(0.47 \,\mu\text{ H})C_{\text{IN}} = 10 \,\mu\text{ F}(\text{GRM155R61A106M})$ $C_{L} = 10 \,\mu \,F(GRM155R61A106M)$



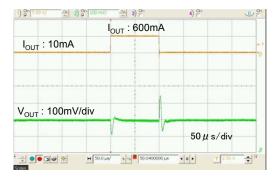
XC9259A33E (PWM/PFM Automatic Control) $V_{IN} = 5.0V V_{OUT} = 3.3V f_{OSC} = 6.0MHz I_{OUT} = 10mA \Rightarrow 600mA$ L = GLCLKR4701A(0.47 μ H)C_{IN} = 10 μ F(GRM155R61A106M) $C_{L} = 10 \,\mu\,F \times 2(GRM155R61A106M)$



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(19) Load Transient Response

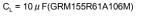
- V_{IN} = 5.0V V_{OUT} = 1.2V f_{OSC} = 1.2MHz I_{OUT} = 10mA \Rightarrow 600mA
- L = LTF5022T-4R7N2R0-LC(4.7 μ H)C_{IN} = 10 μ F(GRM155R61A106M)
- $C_{L} = 10 \,\mu \,F(GRM155R61A106M)$

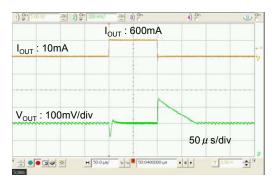


XC9259A12C (PWM/PFM Automatic Control)

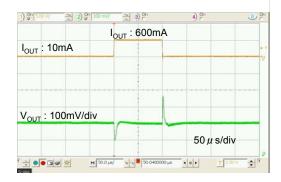
 V_{IN} = 5.0V V_{OUT} = 1.2V f_{OSC} = 1.2MHz I_{OUT} = 10mA \Rightarrow 600mA

L = LTF5022T-4R7N2R0-LC(4.7 μ H)C_{IN} = 10 μ F(GRM155R61A106M)



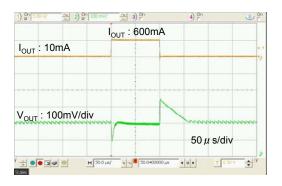


XC9259A18C PWM Control) $V_{IN} = 5.0V V_{OUT} = 1.8V f_{OSC} = 1.2MHz I_{OUT} = 10mA \Rightarrow 600mA$ L = LTF5022T-4R7N2R0-LC(4.7 μ H)C_{IN} = 10 μ F(GRM155R61A106M) $C_1 = 10 \,\mu \,F(GRM155R61A106M)$



XC9259A18C (PWM/PFM Automatic Control)

V_{IN} = 5.0V V_{OUT} = 1.8V f_{OSC} = 1.2MHz I_{OUT} = 10mA ⇒ 600mA L = LTF5022T-4R7N2R0-LC(4.7 μ H)C_{IN} = 10 μ F(GRM155R61A106M) $C_1 = 10 \,\mu \,F(GRM155R61A106M)$



XC9259A33C (PWM Control)

 V_{IN} = 5.0V V_{OUT} = 3.3V f_{OSC} = 1.2MHz I_{OUT} = 10mA \Rightarrow 600mA

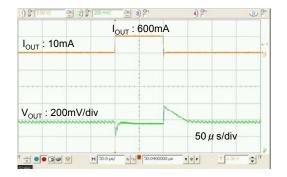
L = LTF5022T-4R7N2R0-LC(4.7 μ H)C_{IN} = 10 μ F(GRM155R61A106M) $C_1 = 10 \,\mu \,F(GRM155R61A106M)$

1) 양 [500 V/ 곳 2) 양 [200 mV	2 3) 위	4) Pr	9 °
	I _{OUT} : 600mA		
I _{OUT} : 10mA			+ 1
	÷		
difeteta zatolat atolatoza activ			
V _{OUT} : 200mV/div			
		50 μ s/di	v
H 200	µs/ <u>s</u> so.0400000 p	A 101 T	хох 🔹 (

XC9259A33C (PWM/PFM Automatic Control)

V_{IN} = 5.0V V_{OUT} = 3.3V f_{OSC} = 1.2MHz I_{OUT} = 10mA ⇒ 600mA L = LTF5022T-4R7N2R0-LC(4.7 μ H)C_{IN} = 10 μ F(GRM155R61A106M)

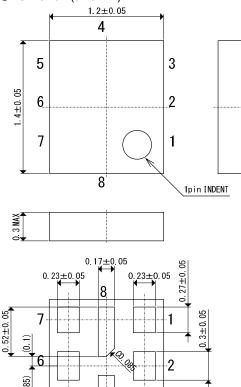
 $C_1 = 10 \,\mu \,F(GRM155R61A106M)$

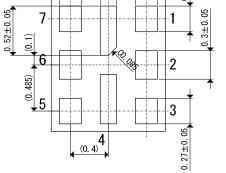


XC9259A12C (PWM Control)

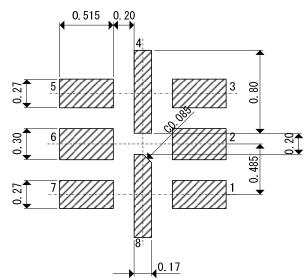
■PACKAGING INFORMATION



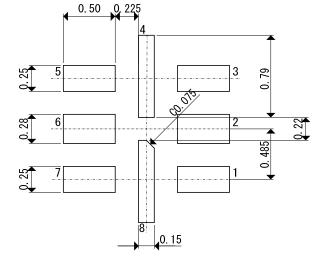




●LGA-8B01 Reference Pattern Layout (unit: mm)



●LGA-8B01 Reference Metal Mask Design (unit: mm)

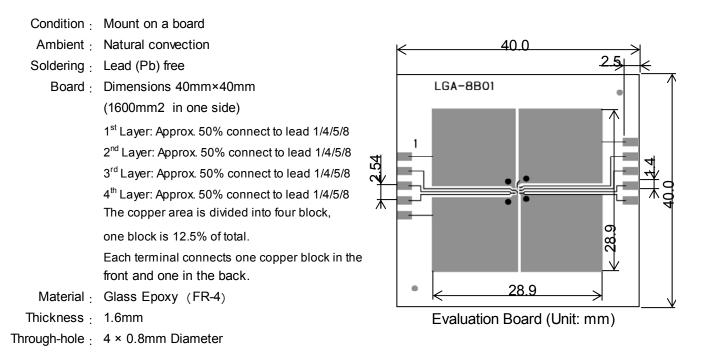


PACKAGING INFORMATION (Continued)

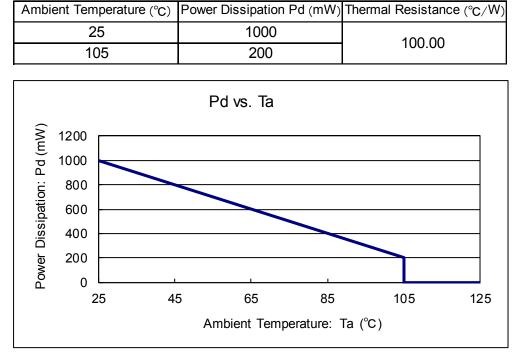
●LGA-8B01Power Dissipation 105°C (40mm x 40mm Standard board)

Power dissipation data for the LGA-8B01 is shown in this page. The value of power dissipation varies with the mount board conditions. Please use this data as one of reference data taken in the described condition.

1. Measurement Condition (Reference data)



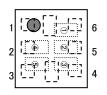
2. Power Dissipation vs. Ambient Temperature



Board Mount (Tjmax=125°C)

■MARKING RULE

LGA-8B01



① represents products series

MARK	PRODUCT SERIES		
E	XC9259A*****-G		
F	XC9259B*****-G		

② represents integer and oscillation frequency of the output voltage

OUTPUT	MARK			
VOLTAGE (V)	f _{OSC} =1.2MHz (XC9259***C**-G)	f _{OSC} =6.0MHz (XC9259***E**-G)		
0.x	N	U		
1.x	Р	V		
2.x	R	Х		
3.x	Т	Y		

③ represents decimal number of the output voltage

Vout(V)	MARK	PRODUCT SERIES
X.00	0	XC9259**0***-G
X.05	А	XC9259**A***-G
X.10	1	XC9259**1***-G
X.15	В	XC9259**B***-G
X.20	2	XC9259**2***-G
X.25	С	XC9259**C***-G
X.30	3	XC9259**3***-G
X.35	D	XC9259**D***-G
X.40	4	XC9259**4***-G
X.45	E	XC9259**E***-G
X.50	5	XC9259**5***-G
X.55	F	XC9259**F***-G
X.60	6	XC9259**6***-G
X.65	Н	XC9259**H***-G
X.70	7	XC9259**7***-G
X.75	К	XC9259**K***-G
X.80	8	XC9259**8***-G
X.85	L	XC9259**L***-G
X.90	9	XC9259**9***-G
X.95	М	XC9259**M***-G

Example (MARK 2), 3)

	MARK					
OSCILLATION FREQUENCY	XC9259*33***		XC9259*2C***		XC9259*1L***	
FREQUENCT	2	3	2	3	2	3
1.2MHz	Т	3	R	С	Р	L
6.0MHz	Y	3	Х	С	V	L

(4) (5) represents production lot number

01~09, 0A~0Z, 11~9Z, A1~A9, AA~AZ, B1~ZZ in order.

(G, I, J, O, Q, W excluded)

* No character inversion used.

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